



TLC59211 8-Bit DMOS Sink Driver

1 Features

- DMOS Process
- High Voltage Output ($V_{ds} = 30\text{ V}$)
- Output Current on Each Channel ($I_{ds}\text{ Max} = 200\text{ mA}$)
- Latch-Up Performance Exceeds 250 mA Per JEDEC Standard JESD-17
- ESD Protection Exceeds JESD 22
 - 2000-V Human Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged Device Model (C101)
- LED Driver Application
- Output Clamp Diode (Parasitic)

2 Applications

- Lamps and Display (LED)
- Hammers
- Relay

3 Description

The TLC59211 is an 8-bit LED and solenoid driver designed for 5-V V_{CC} operation.

The TLC59211 is characterized for operation from -40°C to 85°C .

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)
TLC59211	PDIP (20)	24.33 mm × 6.35 mm
	TSSOP (20)	6.50 mm × 4.40 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Typical Application Diagram

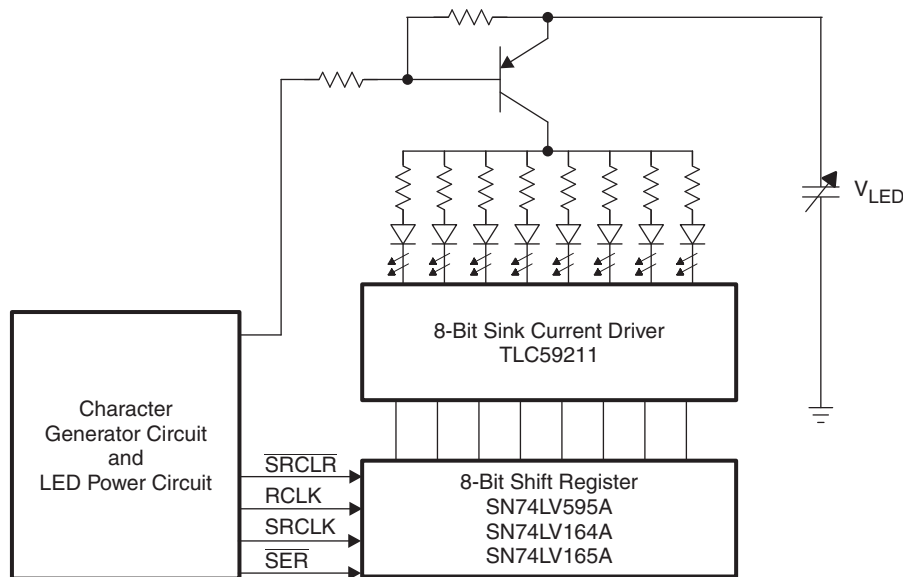


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4 Revision History

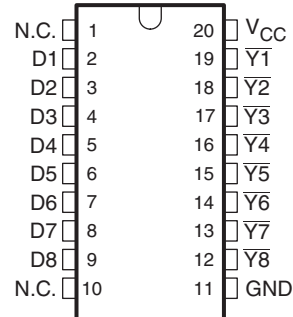
Changes from Original (April 2009) to Revision A

Page

- Added *Pin Configuration and Functions* section, *ESD Ratings* table, *Feature Description* section, *Device Functional Modes*, *Application and Implementation* section, *Power Supply Recommendations* section, *Layout* section, *Device and Documentation Support* section, and *Mechanical, Packaging, and Orderable Information* section **1**
- Removed *Ordering Information* table **1**

5 Pin Configuration and Functions

**N or PW Package
20-Pin PDIP or TSSOP
(Top View)**



N.C. – Not internally connected

Pin Functions

PIN		I/O	DESCRIPTION
NAME	NO.		
N.C.	1	—	No Connection
	10		
D1	2	I	Input control to the current sink driver
D2	3		
D3	4		
D4	5		
D5	6		
D6	7		
D7	8		
D8	9		
$\overline{Y1}$	19	O	Output to load
$\overline{Y2}$	18		
$\overline{Y3}$	17		
$\overline{Y4}$	16		
$\overline{Y5}$	15		
$\overline{Y6}$	14		
$\overline{Y7}$	13		
$\overline{Y8}$	12		
GND	11	—	Ground
VCC	20	I	Supply voltage

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

		MIN	MAX	UNIT
V _{CC}	Supply voltage	−0.5	7	V
D	Input voltage	−0.5	7	V
V _{ds}	Output voltage	H output	32	V
I _{ds}	Output current	1 bit for output low	200	mA
I _{IK}	Input clamp current	V _I < 0 V	−20	mA
	Operating free-air temperature	−40	85	°C
T _{stg}	Storage temperature	−65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

		VALUE	UNIT
V _(ESD)	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±2000
		Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾	±100

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

V_{CC} = 3 V to 5.5 V

		MIN	MAX	UNIT
V _{CC}	Supply voltage	3	5.5	V
V _{IH}	High-level input voltage	V _{CC} × 0.7	V _{CC}	V
V _{IL}	Low-level input voltage	0	V _{CC} × 0.3	V
V _{ds}	Output voltage		30	V
I _{ds}	Output current	N package	Duty cycle < 42%	200
			Duty cycle < 100%	130
		PW package	Duty cycle < 24%	200
			Duty cycle < 100%	95
T _A	Operating free-air temperature	−40	85	°C

6.4 Thermal Information

THERMAL METRIC ⁽¹⁾		TLC59211		UNIT
		N (PDIP)	PW (TSSOP)	
		20 PINS	20 PINS	
R _{θJA}	Junction-to-ambient thermal resistance	54.4	94.3	°C/W
R _{θJC(top)}	Junction-to-case (top) thermal resistance	46.6	28.3	°C/W
R _{θJB}	Junction-to-board thermal resistance	35.4	45.7	°C/W
Ψ _{JT}	Junction-to-top characterization parameter	23.0	1.6	°C/W
Ψ _{JB}	Junction-to-board characterization parameter	35.3	45.1	°C/W
R _{θJC(bot)}	Junction-to-case (bottom) thermal resistance	—	—	°C/W

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

6.5 Electrical Characteristics $V_{CC} = 3\text{ V to }3.6\text{ V}$

over recommended operating free-air temperature range, $V_{CC} = 3\text{ V to }3.6\text{ V}$, $T_A = -40^\circ\text{C to }85^\circ\text{C}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT	
V _{t+}	Positive-going input threshold	D		2.52			V	
V _{t−}	Negative-going input threshold	D		0.9			V	
V _t	Hysteresis	D		0.33			1.32	V
I _{IH}	High-level input current	V _{CC} = 3.6 V, V _I = 3.6V		0			1	μA
I _{IL}	Low-level input current	V _{CC} = 3.6 V, V _I = 0 V		0			−1	μA
I _{OZ}	Leakage current	V _{ds} = 30 V					5	μA
I _{off}	Leakage current	V _I = 0 to 3.6 V, V _O = 0 to 30 V, V _{CC} = 0		0			5	μA
I _{CC}	Supply current	V _I = 0 to 3.6 V, V _{CC} = 3.6 V	Output = all OFF	0			5	μA
			Output = all ON	0			5	
V _{OL}	Low-level output voltage	V _{CC} = 3 V, I _{OL} = 100 mA		0.35			0.7	V
								V
r _{ON}	ON-state resistance	V _{CC} = 3 V, I _O = 100 mA		3.5			7	Ω
C _i	Input capacitance	V _I = V _{CC} or GND		5				pF

6.6 Electrical Characteristics $V_{CC} = 4.5\text{ V to }5.5\text{ V}$

over recommended operating free-air temperature range, $V_{CC} = 4.5\text{ V to }5.5\text{ V}$, $T_A = -40^\circ\text{C to }85^\circ\text{C}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
V _{t+}	Positive-going input threshold	D, $\overline{\text{CLR}}$, CLK				3.5	V
V _{t−}	Negative-going input threshold	D, $\overline{\text{CLR}}$, CLK		1.5			V
V _t	Hysteresis	D, $\overline{\text{CLR}}$, CLK		0.5		2	V
I _{IH}	High-level input current	V _{CC} = 5.5 V, V _I = 5.5 V			0	1	μA
I _{IL}	Low-level input current	V _{CC} = 5.5 V, V _I = 0 V			0	−1	μA
I _{OZ}	Leakage current	V _{ds} = 30 V				5	μA
I _{off}	Leakage current	V _I = 0 to 5 V, V _O = 0 to 30 V, V _{CC} = 0			0	5	μA
I _{CC}	Supply current	V _I = 0 to 5 V, V _O = 0 to 30 V, V _{CC} = 0	Output = all OFF		0	5	μA
			Output = all ON		0	5	
V _{OL}	Low-level output voltage	V _{CC} = 4.5 V, I _O = 100 mA			0.2	0.35	V
		V _{CC} = 4.5 V, I _O = 200 mA			0.5	0.7	V
r _{ON}	ON-state resistance	V _{CC} = 4.5 V, I _O = 100 mA			2	3.5	Ω
C _i	Input capacitance	V _I = V _{CC} or GND			5		pF

6.7 Switching Characteristics $V_{CC} = 3\text{ V to }3.6\text{ V}$

over operating free-air temperature range, $V_{CC} = 3\text{ V to }3.6\text{ V}$, $T_A = -40^\circ\text{C to }85^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			$T_A = -40^\circ\text{C to }85^\circ\text{C}$		UNIT
			MIN	TYP	MAX	MIN	MAX	
t_{TLH}	Output = low to high	$C_L = 30\text{ pF}$, $R_L = 240\text{ }\Omega$, 24-V pullup		200	450		450	ns
t_{THL}	Output = high to low	$C_L = 30\text{ pF}$, $R_L = 240\text{ }\Omega$, 24-V pullup		300	450		480	ns
t_{PLH}	Output = low to high	$C_L = 30\text{ pF}$, $R_L = 240\text{ }\Omega$, 24-V pullup		450	650		800	ns
t_{PHL}	Output = high to low	$C_L = 30\text{ pF}$, $R_L = 240\text{ }\Omega$, 24-V pullup		450	650		800	ns

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6.8 Switching Characteristics $V_{CC} = 4.5\text{ V to }5.5\text{ V}$

over operating free-air temperature range, $V_{CC} = 4.5\text{ V to }5.5\text{ V}$, $T_A = -40^\circ\text{C to }85^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			$T_A = -40^\circ\text{C to }85^\circ\text{C}$		UNIT
			MIN	TYP	MAX	MIN	MAX	
t_{TLH}	Output = low to high	$C_L = 30\text{ pF}$, $R_L = 240\ \Omega$, 24-V pullup		180	220		260	ns
t_{THL}	Output = high to low	$C_L = 30\text{ pF}$, $R_L = 240\ \Omega$, 24-V pullup		290	430		460	ns
t_{PLH}	Output = low to high	$C_L = 30\text{ pF}$, $R_L = 240\ \Omega$, 24-V pullup		320	470		510	ns
t_{PHL}	Output = high to low	$C_L = 30\text{ pF}$, $R_L = 240\ \Omega$, 24-V pullup		320	470		510	ns

6.9 Typical Characteristics

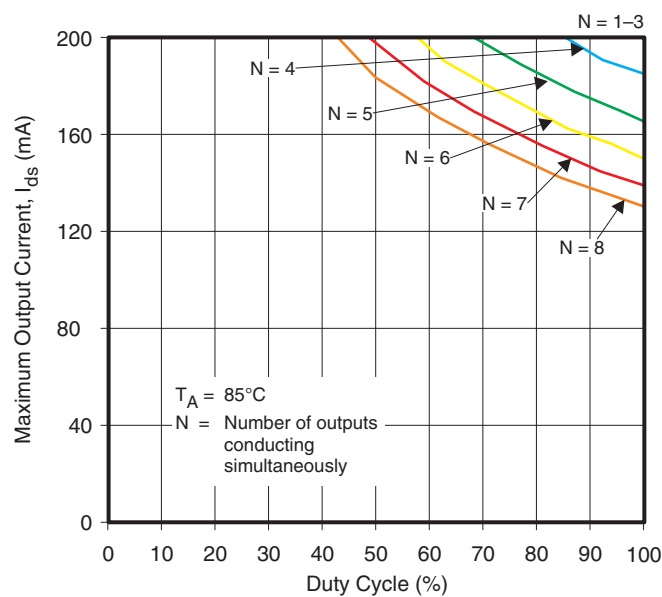
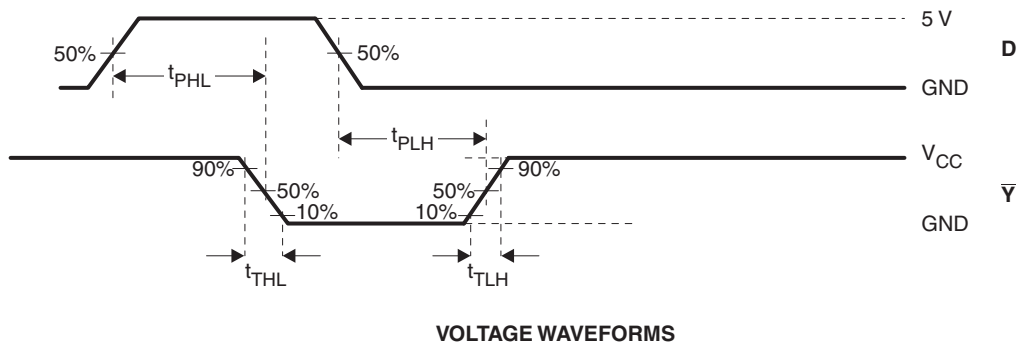
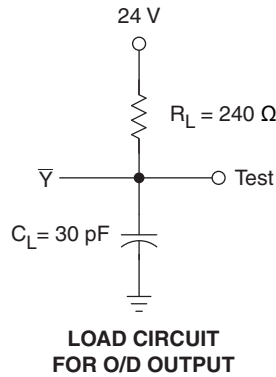


Figure 1. Maximum Output Currents vs Duty Cycle in PDIP (N) Package

7 Parameter Measurement Information



- A. C_L includes probe and jig capacitance.
- B. All input pulses are supplied by generators having the following characteristics: $\text{PRR} \leq 1\ \text{MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 3\ \text{ns}$, and $t_f \leq 3\ \text{ns}$.
- C. The outputs are measured one at a time with one transition per measurement.
- D. t_{PLH} and t_{PHL} are the same as t_{pd} .

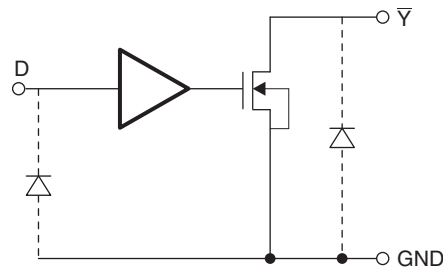
Figure 2. Test Circuit and Voltage Waveforms

8 Detailed Description

8.1 Overview

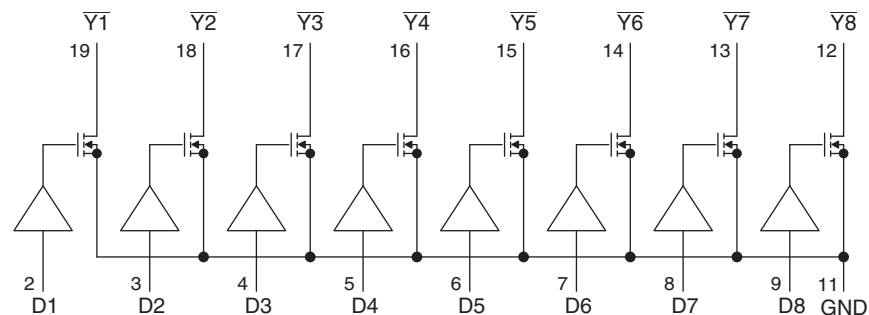
The TLC59211 is an 8-bit parallel LED and solenoid driver designed for 5-V V_{CC} operation. Each channel is individually controlled by its input.

8.2 Functional Block Diagram



8.3 Feature Description

Each of the 8 channels is controlled by its input D_n . When D_n is logic high, the current sink is enabled, output is low. When D_n is logic low, the current sink is disabled, output is pulled high.



(1) This symbol is in accordance with ANSI/IEEE Standard 91-1984 and IEC Publication 617-12.

Figure 3. Logic Symbol

8.4 Device Functional Modes

[Table 1](#) lists the functional modes of the TLC59211.

Table 1. Function Table (Each Latch)⁽¹⁾

INPUTS	OUTPUT
D	$\bar{Y}$
L	H*
H	L

(1) L: Low-level
H: High-level
H*: with pullup resistor

9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

In LED display application, TLC59211 is used to drive the current sink for 8 LEDs in parallel. LED display pattern can be created by providing different bit pattern. LED can be duty cycled by either duty cycling the LED supply or the control bit.

9.2 Typical Application

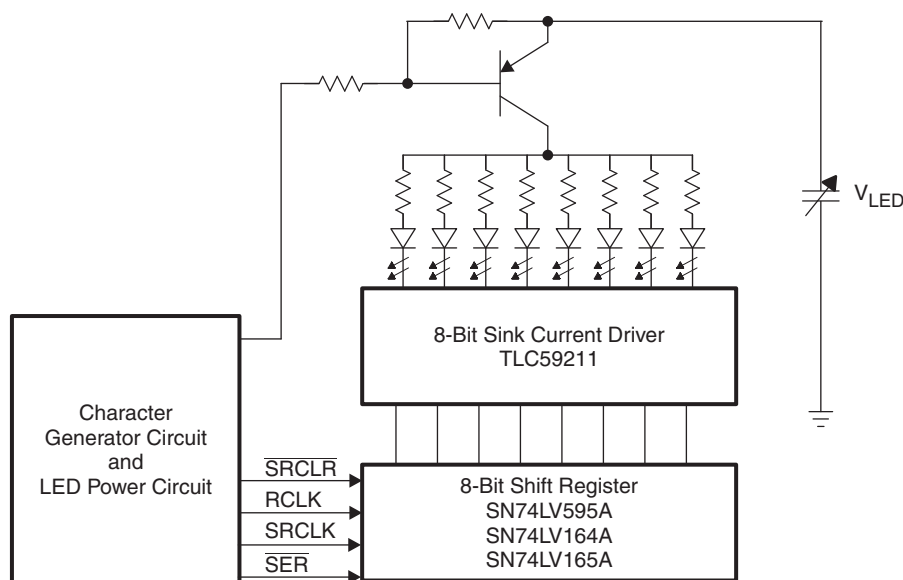


Figure 4. LED Display Implementation With TLC59211

9.2.1 Design Requirements

For LED display application, an 8-bit shift register is used to provide the input control for TLC59211. A character generator circuit and LED power circuit is used to generate the bit pattern written into the shift register and provide the power control for the entire LED array. The LED power circuit controls the total current into the array and can also power cycle the LED array. For simple implementation, LED power circuit could be eliminated. The V_{LED} can be connected directly to the resistor and LED string.

9.2.2 Detailed Design Procedure

The combination of LED and resistor sets the current of the LED.

$$V_R + V_L = V_{LED}, I = (V_{LED} - V_L)/R \quad (1)$$

The maximum current through each channel of TLC59211 is determined by the number of the LEDs that are on and the duty cycle according to Figure 5 for TSSOP package.

Typical Application (continued)

9.2.3 Application Curve

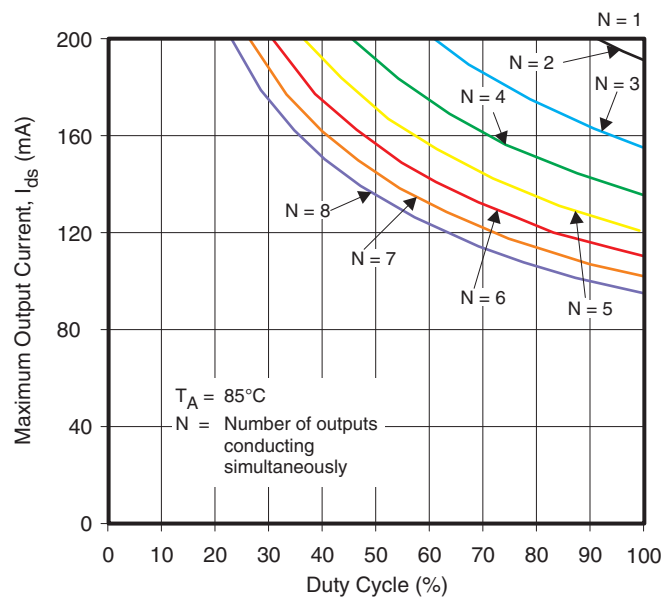


Figure 5. Maximum Output Currents vs Duty Cycle in TSSOP (PW) Package

10 Power Supply Recommendations

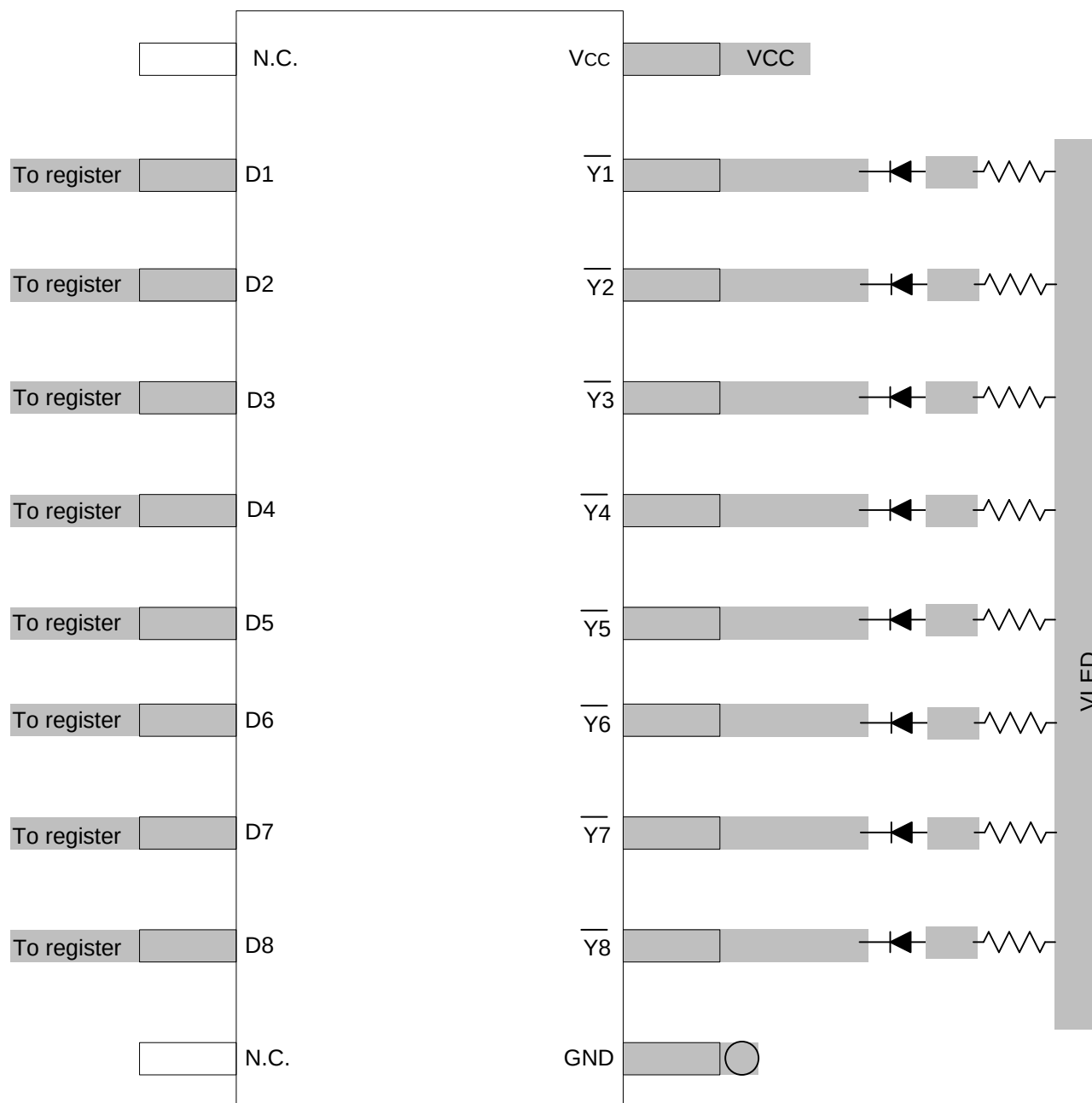
The supply voltage to TLC59211 is from 3.3 V to 5.5 V. The voltage at output can be up to 30 V.

11 Layout

11.1 Layout Guidelines

The traces that carry current from the LED cathodes to the OUTx pins must be wide enough to support the current (up to 200 mA).

11.2 Layout Example



○ VIA to GND

Figure 6. Layout Example Recommendation

12 Device and Documentation Support

12.1 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

12.2 Trademarks

E2E is a trademark of Texas Instruments.
All other trademarks are the property of their respective owners.

12.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

12.4 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TLC59211IN	Active	Production	PDIP (N) 20	20 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC59211IN
TLC59211IN.A	Active	Production	PDIP (N) 20	20 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC59211IN
TLC59211IPWR	Active	Production	TSSOP (PW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	Y59211
TLC59211IPWR.A	Active	Production	TSSOP (PW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	Y59211

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

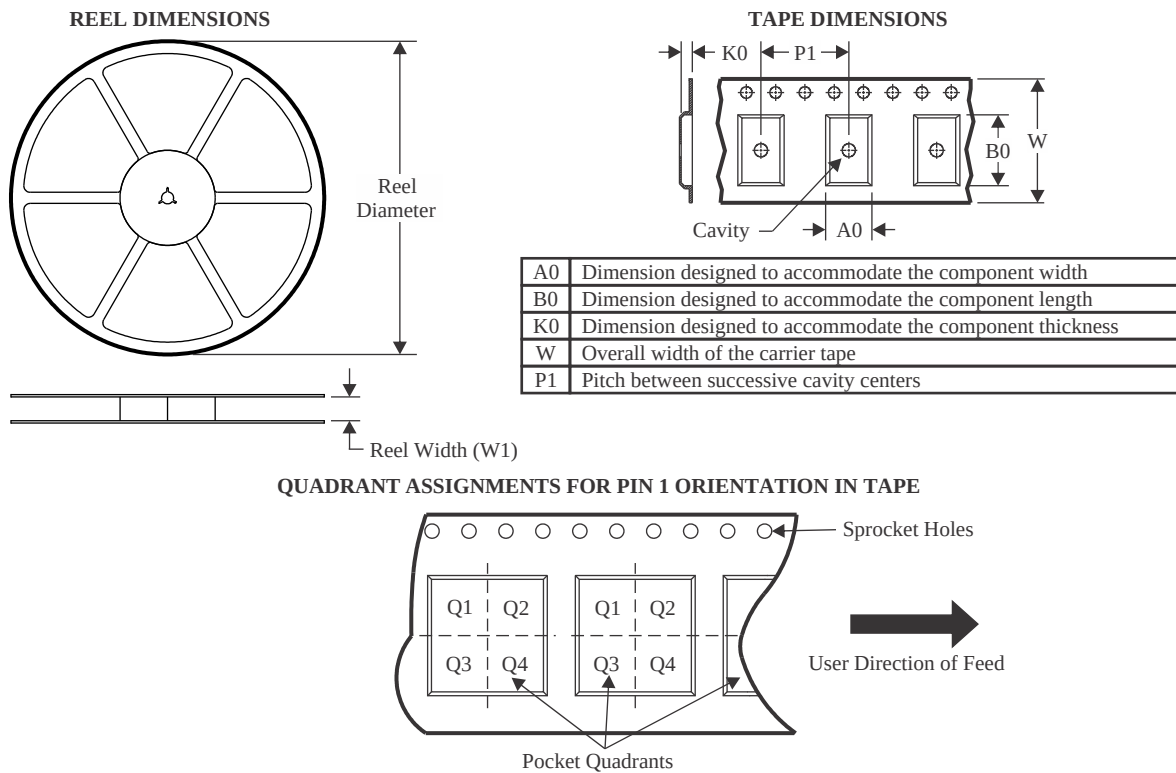
⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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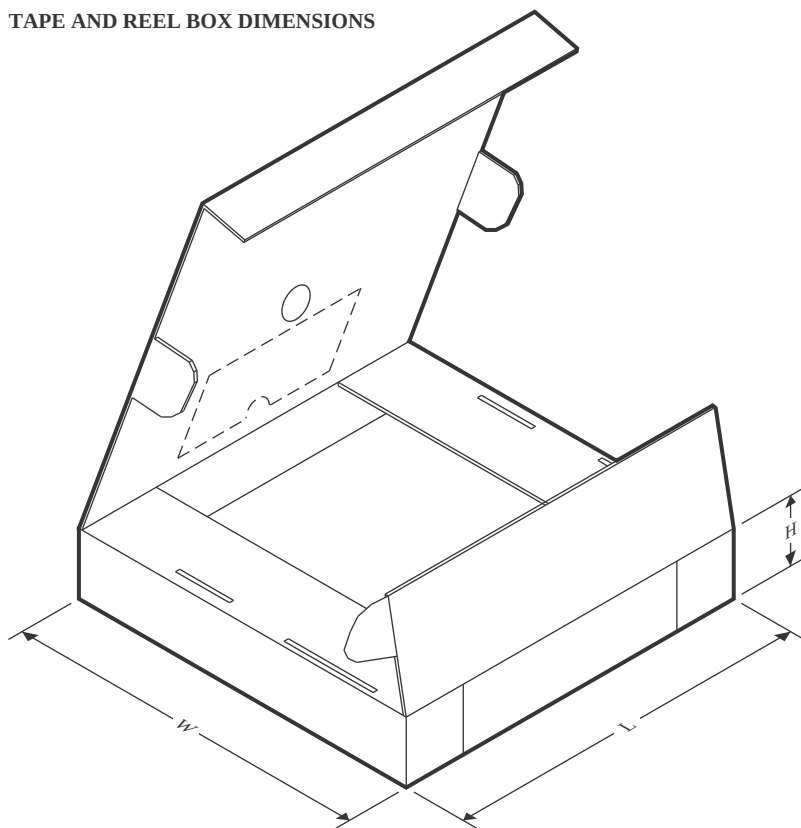
TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLC59211IPWR	TSSOP	PW	20	2000	330.0	16.4	6.95	7.0	1.4	8.0	16.0	Q1

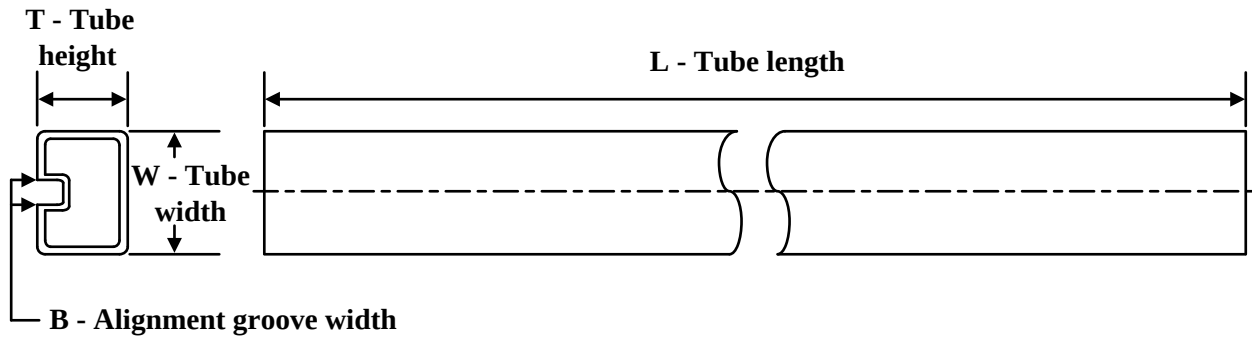
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

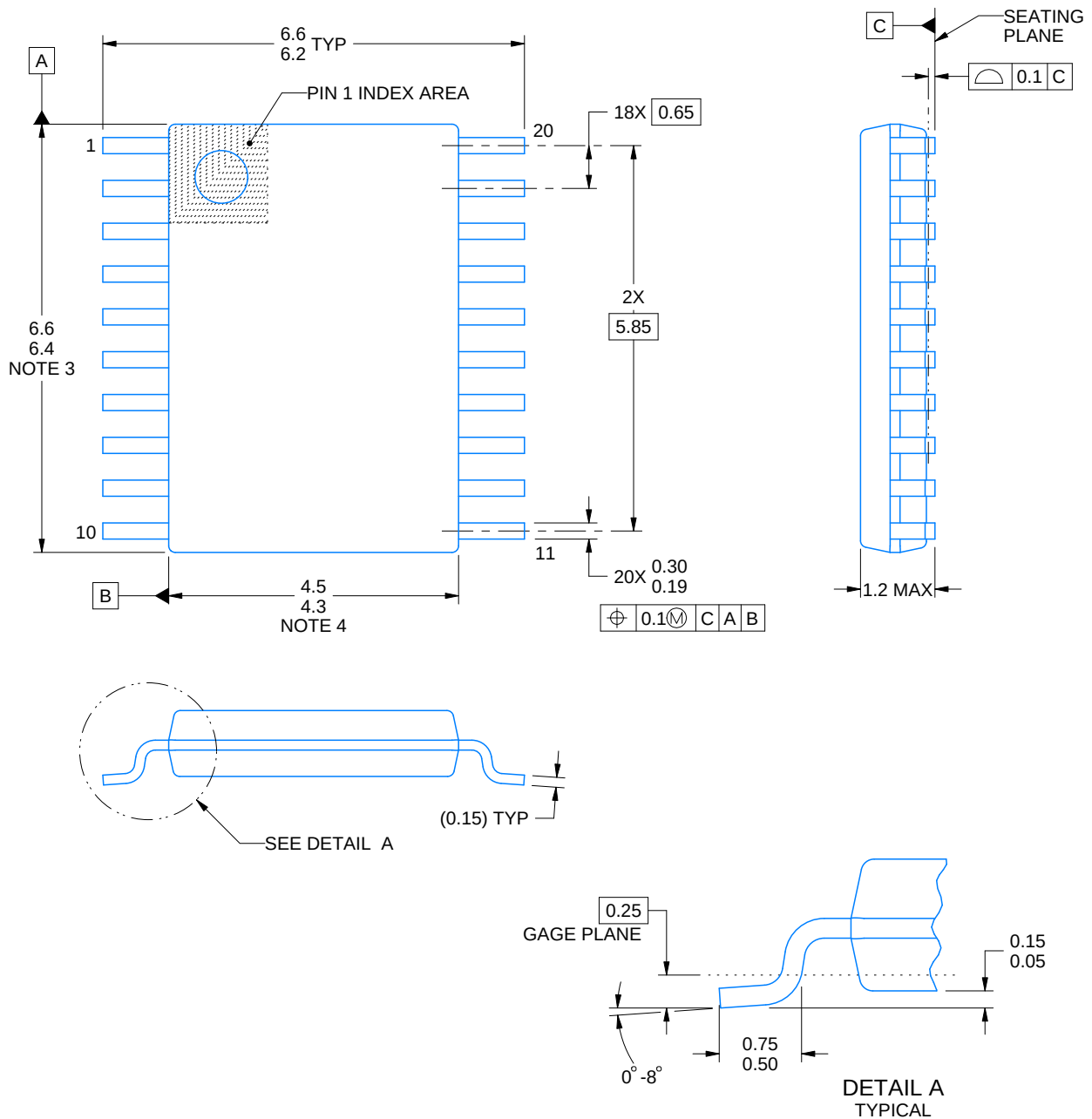
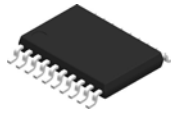
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLC59211IPWR	TSSOP	PW	20	2000	353.0	353.0	32.0

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
TLC59211IN	N	PDIP	20	20	506	13.97	11230	4.32
TLC59211IN.A	N	PDIP	20	20	506	13.97	11230	4.32



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NOTES:

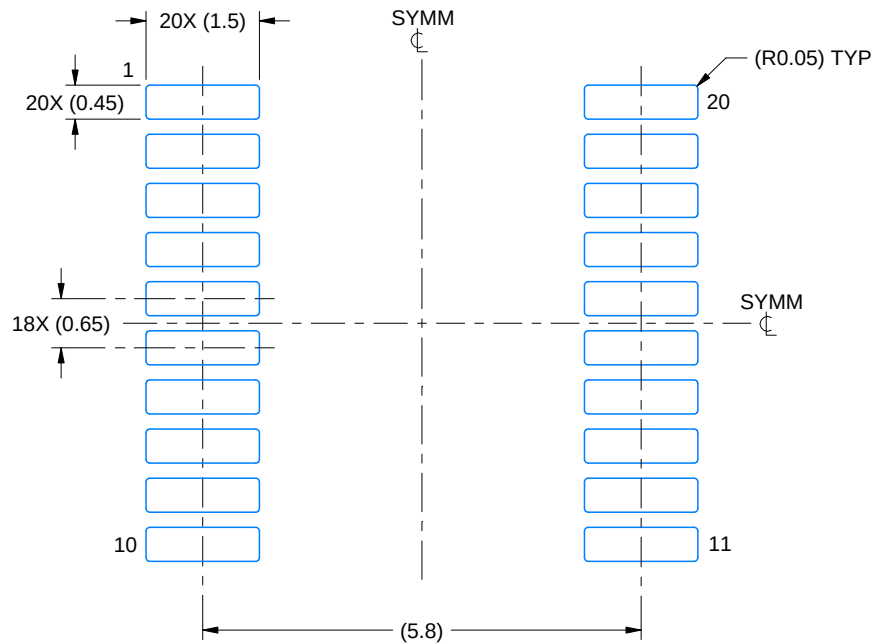
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

EXAMPLE BOARD LAYOUT

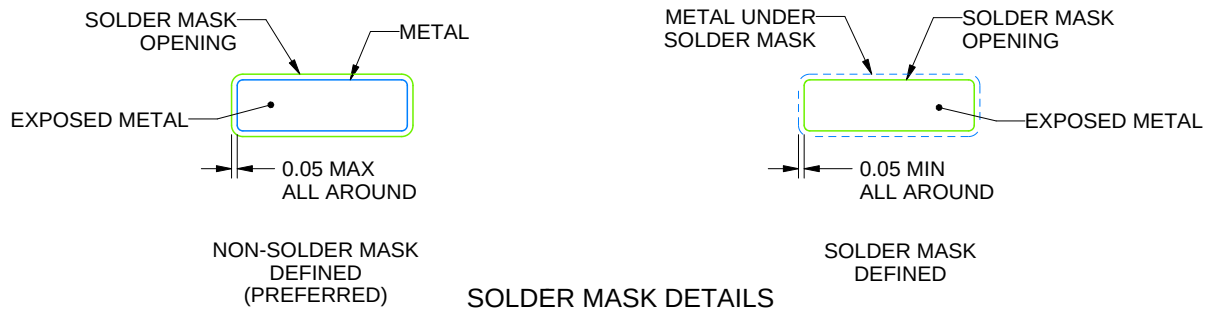
PW0020A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 10X



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NOTES: (continued)

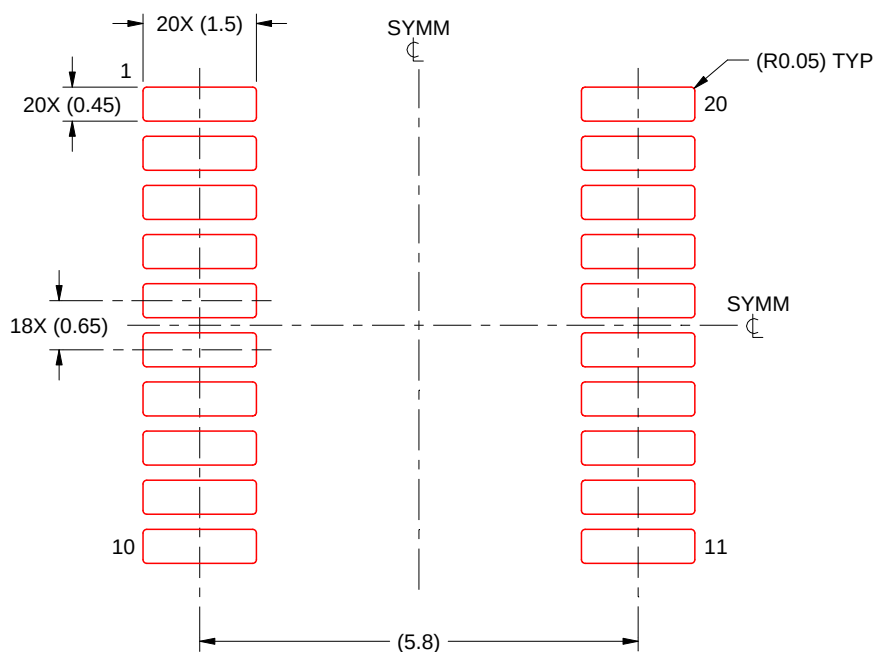
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

PW0020A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE: 10X

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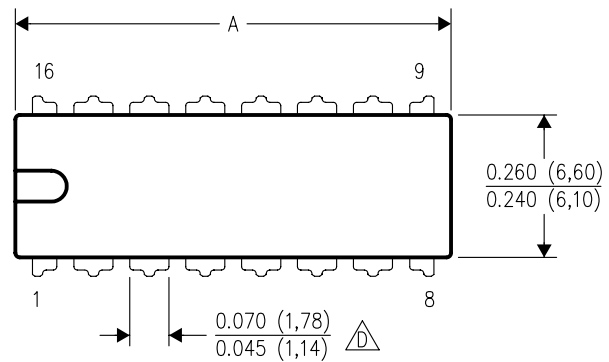
NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

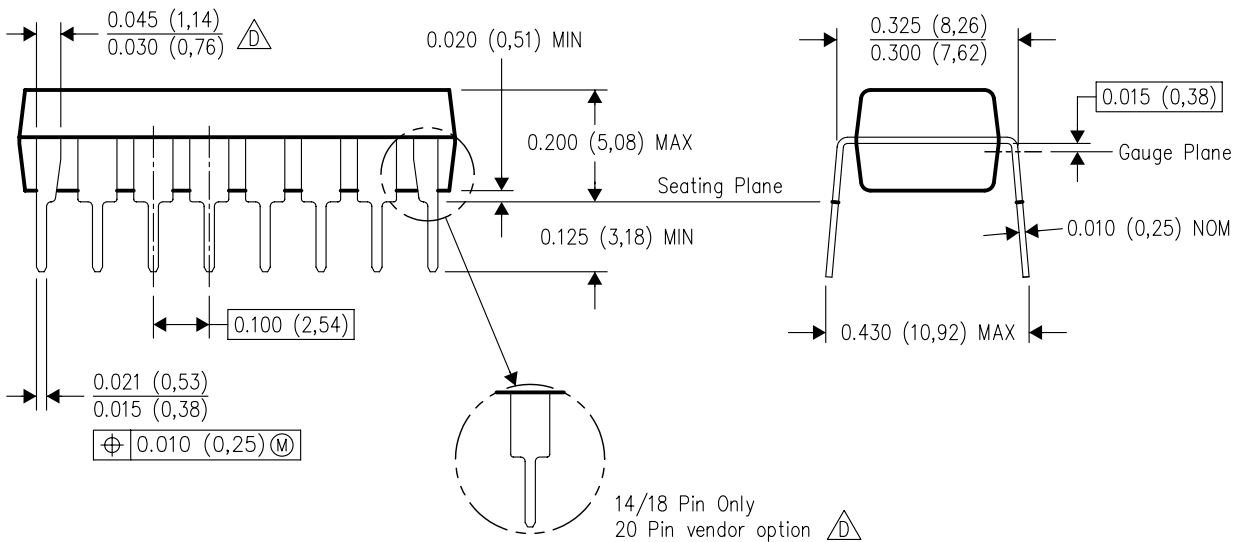
N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS **	14	16	18	20
DIM				
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



14/18 Pin Only
20 Pin vendor option

4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

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